To the Honorable Assistant Secretary and Co or copy(ies) thereof.

1. Name of conveying party(ies):
   Shiro KATO, Hiroshi YAMAZAKI, Yoshimi HIROKAWA,
   Yoko KAN, Naoyuki YOSHIDA, Kazuo MORIKAGE,
   Yukiko MORIKAGE

2. Name and address of receiving party(ies):
   Name: DAINIPPON PHARMACEUTICAL CO., LTD.
   Street Address: 6-8, Dosho-machi 2-chome, Chuo-ku,
   Osaka-shi, Osaka-fu, Japan
   City: Country: 

3. Nature of conveyance:
   X Assignment ___ Merger
   ___ Security Agreement ___ Change of Name
   ___ Other ___
   Execution Date: December 11, 2002

4. Application number(s) or patent number(s):
   If this document is being filed together with a new application, the execution date of the application is: December 11, 2002
   A. Patent Application No.(s) NEW, filed December 18, 2002
   B. Patent No.(s) , issued

5. Name and address of party to whom correspondence concerning document should be mailed:
   Name: WENDEROTH, LIND & PONACK, L.L.P.
   Attn: Warren M. Cheek, Jr., Esq.
   Street Address: 2033 K Street, N.W., Suite 800
   City: Washington, State: DC ZIP: 20006-1021

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41). . . . . . . . . . . $40.00
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   Warren M. Cheek, Jr., Reg. No. 33,367
   Name of Person Signing
   Signature
   December 18, 2002
   Date

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ASSIGNMENT

In consideration of the sum of One Dollar ($1.00) and other good and valuable consideration paid to each of the undersigned

Shiro KATO, Hiroshi YAMAZAKI, Yoshimi HIROKAWA, Yoko KAN,

Naoyuki YOSHIDA, Kazuo MORIKA and Yukiko MORIKA

the undersigned hereby sell(s) and assign(s) to

DAINTYPON PHARMACEUTICAL CO., LTD.

of 6-8, Dosho-machi 2-chome, Chuo-ku, Osak-shi, Osak-fu, Japan

(herinafter designated as the Assignee) the entire right, title and interest for the United States as defined in 35 USC 100, in the invention known as

(S)-4-AMINO-5-CHLORO-2-METHOXY-N-[1-(2-TETRAHYDROFURYLCARBONYL)-4-PIPERIDINYL METHYL]-4-

PIPERIDINYL]BENZAMIDE, PROCESS FOR THE PREPARATION THEREOF, PHARMACEUTICAL COMPOSITION CONTAINING THE SAME, AND INTERMEDIATE THEREOF

for which an application for patent in the United States has been executed by the undersigned on

December 11, 2002

The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation, division or reissue thereof and to cooperate with the Assignee in every way possible in obtaining evidence and going forward with such interference.

The undersigned agree(s) to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the Assignee.

The undersigned hereby authorize(s) and request(s) the Commissioner of Patents to issue any and all Letters Patents of the United States resulting from said application or any division or divisions or continuing or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.
The undersigned hereby grant(s) the firm of WENDEROTH, LIND & PONACK, L.L.P., 2033 K Street, N.W., Suite 800, Washington, DC 20006, the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent Office for recordation of this document.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

Date Dec. 11, 2002, Name of Inventor Shiro Tate
Date Dec. 11, 2002, Name of Inventor Koshiro Yamazaki
Date Dec. 11, 2002, Name of Inventor Yoshimi Hishikawa
Date Dec. 11, 2002, Name of Inventor Isao Kan
Date Dec. 11, 2002, Name of Inventor Neoyaaki Yoshida
Date Dec. 11, 2002, Name of Inventor Kazuhiro Morishige
Date Dec. 11, 2002, Name of Inventor Yukihiro Morishige

(This assignment should preferably be acknowledged before a United States Consul. If not, then the execution by the Inventor(s) should be witnessed by at least two witnesses who sign here.)

Witness Yamaki Itonishawa
Witness Norio Kageyama

ACKNOWLEDGMENT

______________________________
SS

This __________________ day of __________________, 19 ______, before me personally came the above-named

______________________________

______________________________
Official Signature

______________________________
Official Title

The above application may be more particularly identified as follows:

U.S. Application Serial No. __________________ Filing Date __________________
Applicant Reference No. __________________ Atty. Docket No. __________________
Title of Invention __________________